SPECIFICATIONS

CUSTOMER .

SAMPLE CODE : SH128800T008-ZHA

MASS PRODUCTION CODE . PH128800T008-ZHA

SAMPLE VERSION . 01

SPECIFICATIONS EDITION . 002

DRAWING NO. (Ver.) . LMD-PH128800T008-ZHA (Ver.002)

PACKAGING NO. (Ver.) . PKG-PH128800T008-ZHA (Ver.001)

Customer Approved

Date:

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☐ Preliminary specification for design input

■ Specification for sample approval

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History of Version

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12/12/2023	01	001	Preliminary.	-	Yuan
04/30/2024	01	002	First Sample Modify Mechanical Specifications Modify Optical Characteristics Modify Backlight Characteristics Modify Reliability Test Condition Modify Drawing	- 4 6 9 27 Appendix	Yuan
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1. SPECIFICATIONS

1.1 Features

<u>ltem</u>	<u>Standard Value</u>
Screen Size(Inch)	12.1(Diagonal)
Resolution	1280* (R · G · B) * 800 Dots
Display Mode	Full Viewing Angle、Transmissive、Normally Black
Color	16.7M
Weight	395g
Interface	8 bit LVDS
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer website :
	http://www.powertip.com.tw/news_detail.php?Key=1&cID=1

1.2 Mechanical Specifications

<u>ltem</u>	Standard Value	<u>Unit</u>
Outline Dimension	277.7(W) * 180.6(L) * 9.5(H)	mm

LCD Panel

<u>ltem</u>	<u>Standard Value</u>	<u>Unit</u>
View Area	264.12(W) * 166.2(L)	mm
Active Area	261.12(W) * 163.2(L)	mm

Note: For detailed information please refer to LCM drawing.



1.3 Absolute Maximum Ratings

<u>Item</u>	Symbol	Condition	Min.	Max.	<u>Unit</u>	Remark
Logic Supply Voltage	V_{DD}	GND=0V	-0.3	3.6	V	
Operating Temperature	Top (Ts)	Note 1	-20	+70	°C	_
Storage Temperature	T _{ST} (Ta)	Note 2	-30	+80	°C	-
Storage Humidity	H _D	Ta<60°C	10	+90	%RH	

The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

Note 1: Ts is the temperature of panel's surface.

Note 2: Ta is the ambient temperature of samples.

1.4 DC Electrical Characteristics

<u>ltem</u>	Symbol	<u>Condition</u>	Min.	<u> Typ.</u>	Max.	<u>Unit</u>
Power Supply Voltage for LCD Driver	VDD	-	3.0	3.3	3.6	V
Power Supply Current	IDD	VDD=3.3V	-	300	450	mA



1.5 Optical Characteristics

TFT LCD Panel

VDD=3.3V, Ta=25°C

<u>Item</u>		Symbol	Condition	Min.	Typ.	Max.	<u>Unit</u>	-
Response Tin	ne	Tr + Tf	-	-	30	35	ms	Note2
	Тор	ΘY+		-	85	-		
Viewing Angle	Bottom	ΘΥ-	CR ≥ 10	-	85	-	Dog	Note4
Viewing Angle	Left	ΘХ-	GR 2 10	-	85	1	Deg.	NOIE4
	Right	ΘХ+		-	85	-		
Contrast Rat	io	CR		1000	1200	-	-	Note3
	White	X		0.25	0.30	0.35		
	vviile	Υ		0.29	0.34	0.39		
0 1 1015	Red	Х	Ta = 25°C θX , θY = 0°	0.59	0.64	0.69		
Color of CIE		Υ		0.29	0.34	0.39		N
Coordinate	Green	Х	0,01 = 0	0.24	0.29	0.34	-	Note1
	Olech	Υ		0.57	0.62	0.67		
	Blue	Х		0.09	0.14	0.19		
	Diue	Y		0.01	0.06	0.11		
Average Brightness								
Pattern=white display		IV	If=300mA	850	1000	-	cd/m2	Note1
(With LCD)*2								
Luminance Unifo (With LCD)*	_	ΔВ	If=300mA	70	-	-	%	Note1



Note 1:

*1: △B=B(min) / B(max) * 100%

*2: Measurement Condition for Optical Characteristics:

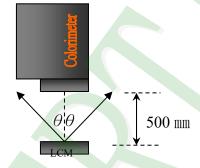
a: Environment: 25°C±5°C / 60±20%R.H, no wind, dark room below 10 Lux at typical lamp current and typical operating frequency

b: Measurement Distance: 500 ± 50 mm, $(\theta = 0^{\circ})$

c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation

d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%





Colorimeter=BM-7 fast

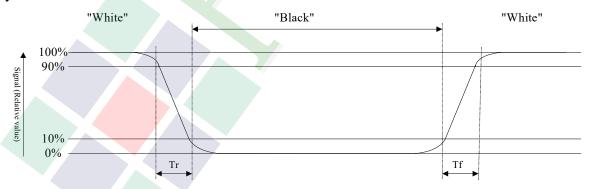
To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

Note 2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

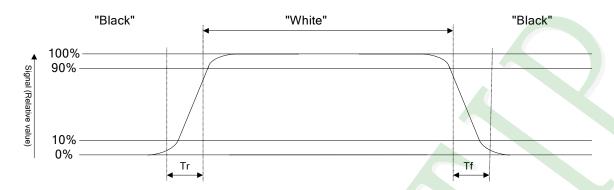
Refer to figure as below:

Normally White





Normally Black



Note 3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

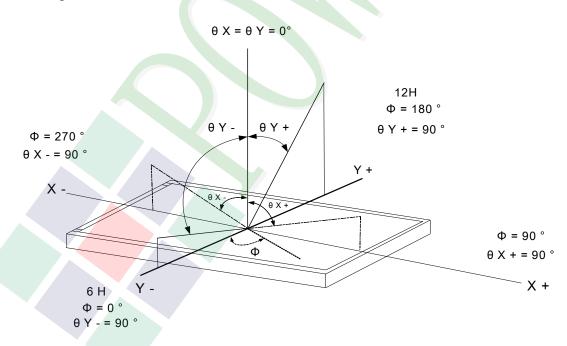
Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state

Note 4: Definition of viewing angle:

Refer to figure as below:





1.6 Backlight Characteristics

Electrical / Optical Characteristics

<u>Item</u>	Symbol	Conditions	Min.	<u>Typ.</u>	Max.	<u>Unit</u>
Forward Voltage	VF	If=300mA	29.7	33.0	36.3	V
Uniformity *1	∆B	II-300IIIA	70			
Color			White	/(

*1 : This value will be changed while mass production.

*2 : △B=B(min) / B(max)% B/L Internal Circuit Diagram

Other Description

<u>Item</u>	Conditions	<u>Description</u>
Life Time	Ta =25°C If= 300 mA	30000 hrs



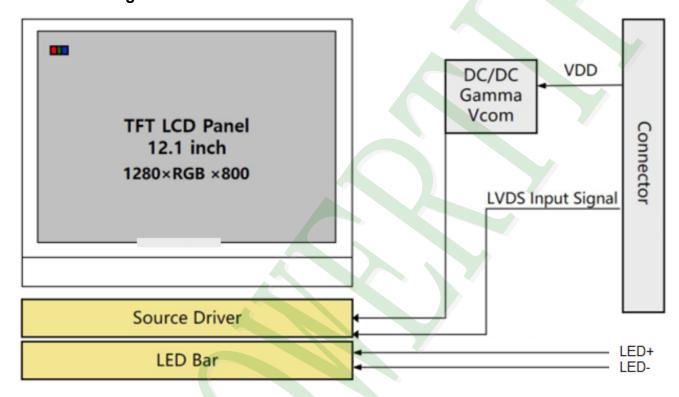
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram





2.2 Interface Pin Description

LCM Interface

Pin No.	<u>Symbol</u>	<u>Description</u>
1	NC	No Connection.
2	VDD	Power Supply.
3	VDD	Power Supply.
4	VDD	Power Supply.
5	NC	No Connection.
6	GND	Ground.
7	GND	Ground.
8	RIN0-	-LVDS Differential Data Input.
9	RIN0+	+LVDS Differential Data Input.
10	GND	Ground.
11	RIN1-	-LVDS Differential Data Input.
12	RIN1+	+LVDS Differential Data Input.
13	GND	Ground.
14	RIN2-	-LVDS Differential Data Input.
15	RIN2+	+LVDS Differential Data Input.
16	GND	Ground.
17	LVDS_CLK-	-LVDS Differential Clock Input.
18	LVDS_CLK+	+LVDS Differential Clock Input.
19	GND	Ground.
20	RIN3-	-LVDS Differential Data Input.
21	RIN3+	+LVDS Differential Data Input.
22	GND	Ground.
23	NC	No Connection.
24	NC	No Connection.
25	GND	Ground.
26	SDA	Serial data input/output for I2C interface
27	SCL	Clock input for I2C interface



Pin No.	<u>Symbol</u>	<u>Description</u>
28	GND	Ground.
29	NC	No Connection.
30	NC	No Connection.
31	GND	Ground.
32	GND	Ground.
33	GND	Ground.
34	NC	No Connection.
35	NC	No Connection.
36	NC	No Connection.
37	NC	No Connection.
38	NC	No Connection.
39	NC	No Connection.
40	NC	No Connection.

CN1: LED Backlight Interface

Pin No.	<u>Symbol</u>	<u>Description</u>
1	LED+	Power Supply for LED Backlight anode input
2	LED-	Power Supply for LED Backlight cathode input

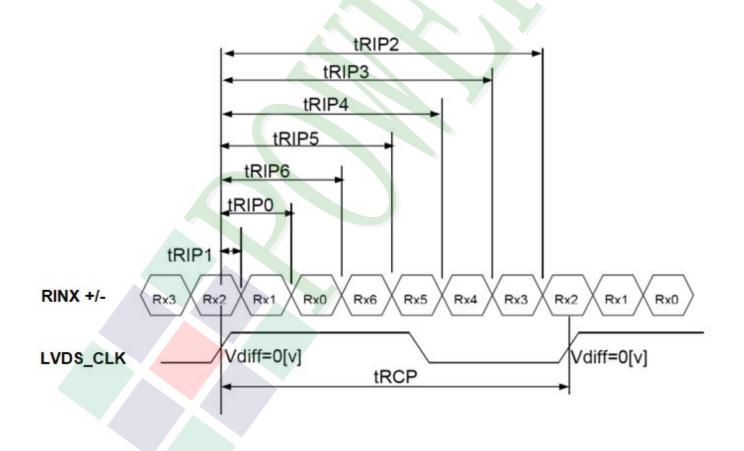


2.3 Timing Characteristics

2.3.1 LVDS Rx Interface Timing Parameter

The specification of the LVDS Rx interface timing parameter

				<u> </u>		
<u>ltem</u>	<u>Symbol</u>	Min.	Typ.	Max.	<u>Unit</u>	<u>Remark</u>
LVDS_CLK	tRCP	10	Т	40	nsec	-
Period						
Receiver Data	tRMG	-0.45	-	+0.45	nsec	fCLKIN=80.9MHz
Input Margin		-0.60	-	+0.60	nsec	fCLKIN=75MHz
Input Data 0	tRIP1	- tRMG	0.0	+ tRMG	Clock	- /
Input Data 1	tRIP0	T/7- tRMG	T/7	T/7+ tRMG	Clock	-
Input Data 2	tRIP6	2 T/7- tRMG	2T/7	2 T/7+ tRMG	Clock	-
Input Data 3	tRIP5	3 T/7- tRMG	3T/7	3 T/7+ tRMG	Clock	-
Input Data 4	tRIP4	4 T/7- tRMG	4T/7	4 T/7+ tRMG	Clock	-
Input Data 5	tRIP3	5 T/7- tRMG	5T/7	5 T/7+ tRMG	Clock	-
Input Data 6	tRIP2	6 T/7- tRMG	6T/7	6 T/7+ tRMG	Clock	-



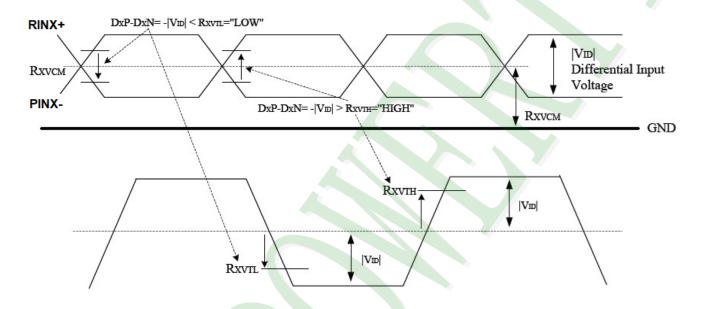


2.3.2 DC Specification

LVDS Receiver Differential Input (DC Characteristics).

<u>Parameter</u>	<u>Symbol</u>	Min.	Typ.	Max.	<u>Unit</u>	<u>Conditions</u>
Differential Input High Threshold	Vth	-	-	100	mV	V _{CM} =+1.2V
Differential Input Low Threshold	VtI	-100	-	-	mV	V _{CM} =+1.2V
Differential Input Voltage	V _{ID}	200	-	600	mV	-
Common Mode Voltage	V_{CM}	1	1.2	1.4	V	-

Single-end Signals

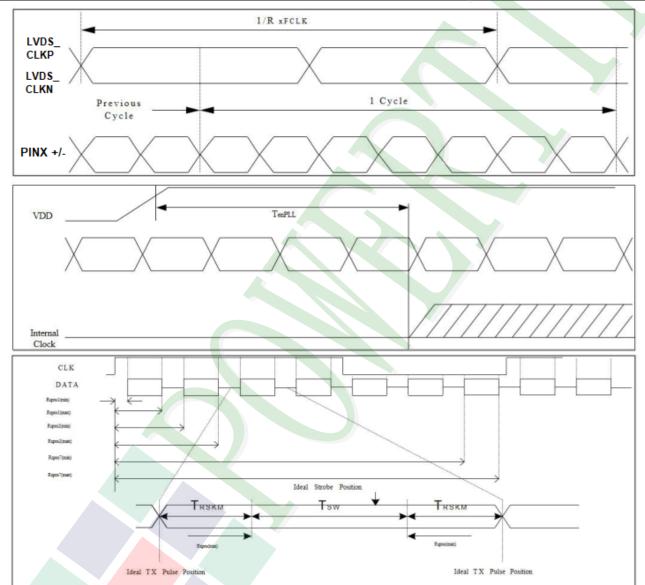




2.3.3 AC Specification

LVDS Receiver Differential Input (AC Characteristics)

<u>Parameter</u>	<u>Symbol</u>	Min.	Typ.	Max.	<u>Unit</u>	<u>Note</u>
LVDS Strobe Width	tSW	200	ı	1	ps	$V_{CM}=+1.2V$ $VID = 200mV$
LVDS Receiver Skew Margin	tRSM	500	-	-	ps	@81MHz





2.3.4 Input Timing (DE mode only)

<u>Parameter</u>	<u>Symbol</u>	Min.	<u>Typ.</u>	Max.	<u>Unit</u>
LVDS Frequency@Frame rate=60Hz	Fclk	69.7	75	80.9	MHz
Horizontal display area	THD		1280		DCLK
HSYNC period time	Тн	1410	1440	1500	DCLK
HSYNC blanking	THBP+THFP	100	160	220	DCLK
Vertical display area	Tvd		800		H
VSYNC period time	Tv	842	838	872	Н
VSYNC blanking	TVBP+TVFP	24	38	72	Н

Note

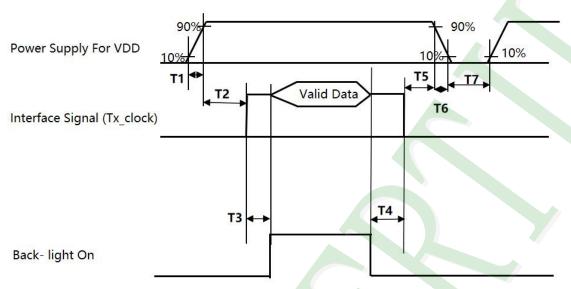
- DE Only Mode , While operation, DE signal should be have the same cycle. The input of HSYNC & VSYNC signal does not have an effect on normal operation.
- 2. Best operation clock frequency is 75Mhz.
- 3. Frequency] = [H Total] * [V Total] * [vertical Frame rate]
 H Total, V Total and Frame rate]should operate within the range between Frequency_Min and Frequency_Max
- 4. Except Best operation clock frequency, FOS(Flicker & Brightness & Crosstalk, Etc.) are not guaranteed.
- 5. Main frequency Max is 80.9Mhz MHz without spread spectrum





2.3.4 Power ON/OFF Sequence

To prevent a latch-up or DC operation of the Open Cell, the power on/off sequence shall be as shown in below



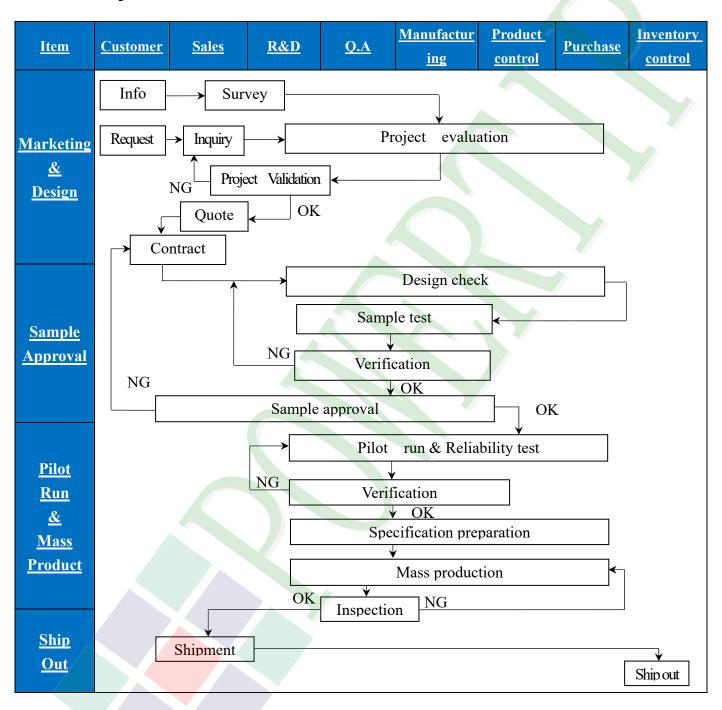
<u>Parameter</u>	Min.	Typ.	Max.	<u>Unit</u>
T1	0.1	-	10	ms
T2	0.1	-	50	ms
Т3	300	-	-	ms
T4	200	-	-	ms
T5	0.1	-	50	S
T6	0.1	-	10	ms
T7	500	-	-	ms

- Note 1: Even though T1 is over the specified value, there is no problem if the rush current is within Spec.
- Note 2: When the power supply VDD is 0V, keep the level of input signals on the low or high impedance;
 - Please avoid floating state of interface signal at invalid period.
 - ※ When the power supply for LCD (VDD) is off, be sure to pull down the valid and invalid data to 0V.
- Note 3: The T3 / T4 is recommended value, the case when failed to meet a minimum specification, abnormal display would be shown. There is no reliability problem.
- Note 4: T6: Voltage of VDD must decay smoothly after power-off, there should be none re-bounding voltage. (customer system decide this value)
- Note 5: T7 should be measured after the Module has been fully discharged between power off and on period

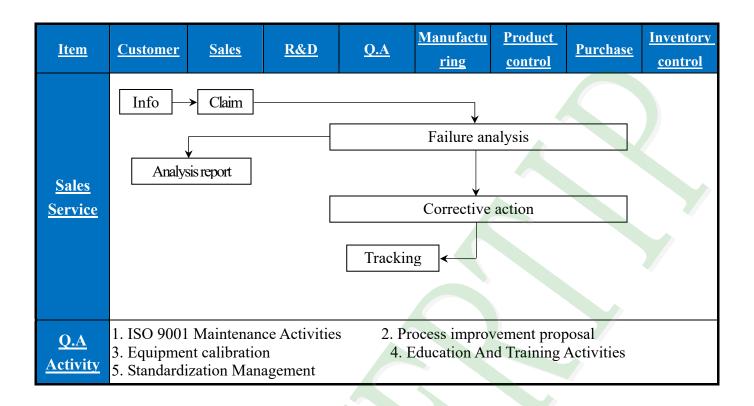


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart



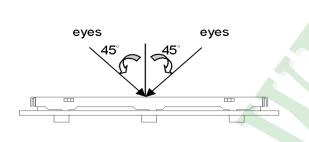






3.2. Inspection Specification

- ◆ Scope: The document shall be applied to TFT-LCD Module for 3. 5" -15" (Ver.B01).
- ♦ Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level II.
- ♦ Equipment: Gauge, MIL-STD, Powertip Tester, Sample
- ◆ Defect Level: Major Defect AQL: 0. 4; Minor Defect AQL: 1. 5
- **◆** OUT Going Defect Level: Sampling.
- ◆ Standard of the product appearance test:
 - a. Manner of appearance test:
 - (1). The test best be under 20W×2 fluorescent light(about 300lux ∼500lux) , and distance of view must be at 30~40 cm.
 - (2). The test direction is base on about around 45° of vertical line.



5% Brightness

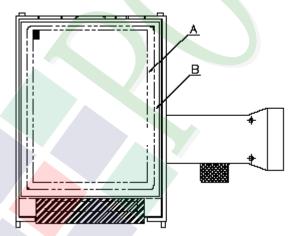
ND fliter

30~40 cm

LCD panel

2.5~3cm

(3). Definition of area.



A area: viewing area

B area: Outside of viewing area

(4). Standard of inspection: (Unit: mm)



◆Specification For TFT-LCD Module 3. 5" ~15":

<u>NO</u>	<u>Item</u>	<u>Criterion</u>	Level
		1. 1The part number is inconsistent with work order of production.	Major
01	Product condition	1. 2 Mixed product types.	Major
		1. 3 Assembled in inverse direction.	Major
02	Quantity	2. 1The quantity is inconsistent with work order of production.	Major
03	Outline dimension	3. 1Product dimension and structure must conform to structure diagram.	Major
		4. 1 Missing line character and icon.	Major
		4. 2 No function or no display.	Major
		4. 3 Display malfunction.	Major
04	Electrical Testing	4. 4 LCD viewing angle defect.	Major
		4. 5 Current consumption exceeds product specifications.	Major
		4. 6Mura cannot be seen through 5% ND filter at 50% Gray, should be judged by the viewing angle of 90 degree.	Minor
05	Dot defect (Bright dot, Dark dot) On -display	Item Acceptance (O'ty) Bright Dot ≤ 4 Defect Joint Dot ≤ 3 Total ≤ 7 5.1 Inspection pattern: full white, full black, Red, Green and blue screens. 5.2 It is defined as dot defect if defect area > 1/2 dot. 5.3 The distance between two dot defect ≥5 mm. 5.4 Bright dot: Dots appear bright and unchanged in visible with 5% ND filter is defined. 5.5 Tiny bright dot: bright dot area ≤ 1/2 dot. a. Dots appear bright and unchanged in visible with 5% ND filter is defined defect and is judged in accordance with 6.1 b. Dots invisible with 5% ND Filter is Ignored.	Minor



◆Specification For TFT-LCD Module 3. 5″ ~15″:

NO	<u>Item</u>		riterion			Level	
110	- Hom					-13431	
06	Black or white Dot, scratch, contamination Round type → X	6. 1 Round type (Non-display or $\frac{\text{Dimension (diameter: }\Phi)}{\Phi \leq 0.25}$ $\frac{0.25 < \Phi \leq 0.50}{\Phi > 0.50}$ $\frac{\text{Total}}{\text{Total}}$ 6. 2 Line type(Non-display or display or displ	display): Acceptance A area Ignore 5 0 5 splay): Width (W) $W \le 0.03$ $3 < W \le 0.05$ $0 < 0.05$	Acceptance A area Ignore 4 2 As round type 5		Minor	
	$\longrightarrow_{L} \bigvee_{L}^{\blacklozenge} W$	→	9" to 15" L ≤ 10.0 0.0	$W \le 0.05$ $05 < W \le 0.10$	Ignore 5 As round type 5	Ignore	
07	Polarizer Bubble	Dimension (diameter: Φ) $\Phi \le 0.25$ $0.25 < \Phi \le 0.50$ $0.50 < \Phi \le 0.80$ $\Phi > 0.80$ Total	Acceptan A area Ignore 4 1 0 5	Igno		Minor	



◆Specification For TFT-LCD Module 3. 5″~15″:

NO	<u>Item</u>	<u>Criterion</u>	Level
		Symbols: X: The length of crack Z: The thickness of crack T: The thickness of glass X: The width of crack W: terminal length a: LCD side length	
		8. 1 General glass chip: 8. 1. 1 Chip on panel surface and crack between panels:	
		Z Z Y	
08	The crack of glass	SP SP [NG]	Minor
		Seal width	
		X Y Z	
		≤ a Crack can't enter viewing area ≤1/2 t	
		≤a Crack can't exceed the half of SP width. 1/2 t < Z ≤2 t	



◆Specification For TFT-LCD Module 3. 5″ ~15″:

NO	<u>Item</u>	<u>Criterion</u>	Level
		Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass 8. 1. 2 Corner crack:	
		8. 1. 2 COTHET CLACK.	
		<u>X</u> <u>Y</u> <u>Z</u>	
		$\leq 1/5$ a Crack can't enter viewing area $Z \leq 1/2$ t	
08	The crack of glass		Minor
	The cruck of glass	8.2 Protrusion over terminal: 8.2.1 Chip on electrode pad:	IVIIIIOI
		W.Y. Z. X. Y. Z. X. X. X. Y. Z. X. X. X. Y. Z. X.	
		W X	
		<u>X</u> <u>Y</u> <u>Z</u>	



◆Specification For TFT-LCD Module 3. 5″~15″:

Symbols: X: The length of crack Z: The thickness of crack W: terminal length t: The thickness of glass a: LCD side length 8. 2. 2 Non-conductive portion: W X X X X X X X X X X X X	X: The length of crack Z: The thickness of crack W: terminal length a: LCD side length 8. 2. 2 Non-conductive portion: $ \frac{X}{Y} \qquad \frac{Y}{X} \qquad \frac{Z}{Y} \qquad Z$
8. 2. 3 Glass remain: X Y Y Y Y Y Y Y	terminal specifications 8. 2. 3 Glass remain: W Pitch Z Z



◆Specification For TFT-LCD Module 3. 5″~15″:

<u>NO</u>	<u>Item</u>	<u>Criterion</u>	Level
		9. 1 Backlight can't work normally.	Major
09	Backlight elements	9. 2 Backlight doesn't light or color is wrong.	Major
		9. 3 Illumination source flickers when lit.	Major
	General	10. 1 Pin type, quantity, dimension must match type in structure diagram.	Major
		10. 2 No short circuits in components on PCB or FPC.	Major
		10. 3 Parts on PCB or FPC must be: no wrong parts, missing parts or excess parts.	Major
10		10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10. 5 The folding and peeled off in polarizer are not acceptable.	Minor
		10. 6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≤1.5 mm.	Minor



4. RELIABILITY TEST

Reliability Test Condition

(Ver.B01)

	(Vel.DOT)						
<u>NO.</u>	TEST ITEM	TEST CONDITION					
1	High Temperature Storage Test	Keep in +80 ±5°C 240 hrs					
2	High Temperature Operating Test	Keep in 70 ±5°C 240 hrs					
3	Low Temperature Storage Test	Keep in -30 ±5°C 240 hrs					
4	Low Temperature Operating Test	Keep in -20 ±5°C 240 hrs					
5	High Temperature / High Humidity Storage Test	Keep in 60 °C / 90% R.H duration for 240 hrs (Excluding the polarizer)					
6	Temperature Cycling Storage Test	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$					
7	ESD Test	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/- 1.Temperature ambiance : 15° C $\sim 35^{\circ}$ C 2.Humidity relative : $30\% \sim 60\%$ 3.Energy Storage Capacitance(Cs+Cd) : $150pF\pm10\%$ 4.Discharge Resistance(Rd) : $330\Omega\pm10\%$ 5.Discharge, mode of operation : Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication : $\pm5\%$)					
8	Vibration Test (Packaged)	1.Sine wave 10~55 Hz frequency (1 min/sweep) 2.The amplitude of vibration :1.5 mm 3.Each direction (X \ Y \ Z) duration for 2 Hrs					
9	Drop Test (Packaged)	Packing Weight (Kg) Drop Height (cm) 0 ~ 45.4 122 45.4 ~ 90.8 76 90.8 ~ 454 61 Over 454 46 Drop Direction : 1 corner / 3 edges / 6 sides each 1 time					

○Result Evaluation Criteria :

Under the display quality test conditions with normal operations with normal operation state. Do not change these conditions as such changes may affect practical display function. (Normal operation state)

Temperature: +20~30°C Humidity: 50~70%

Atmospheric pressure: 86~106Kpa



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

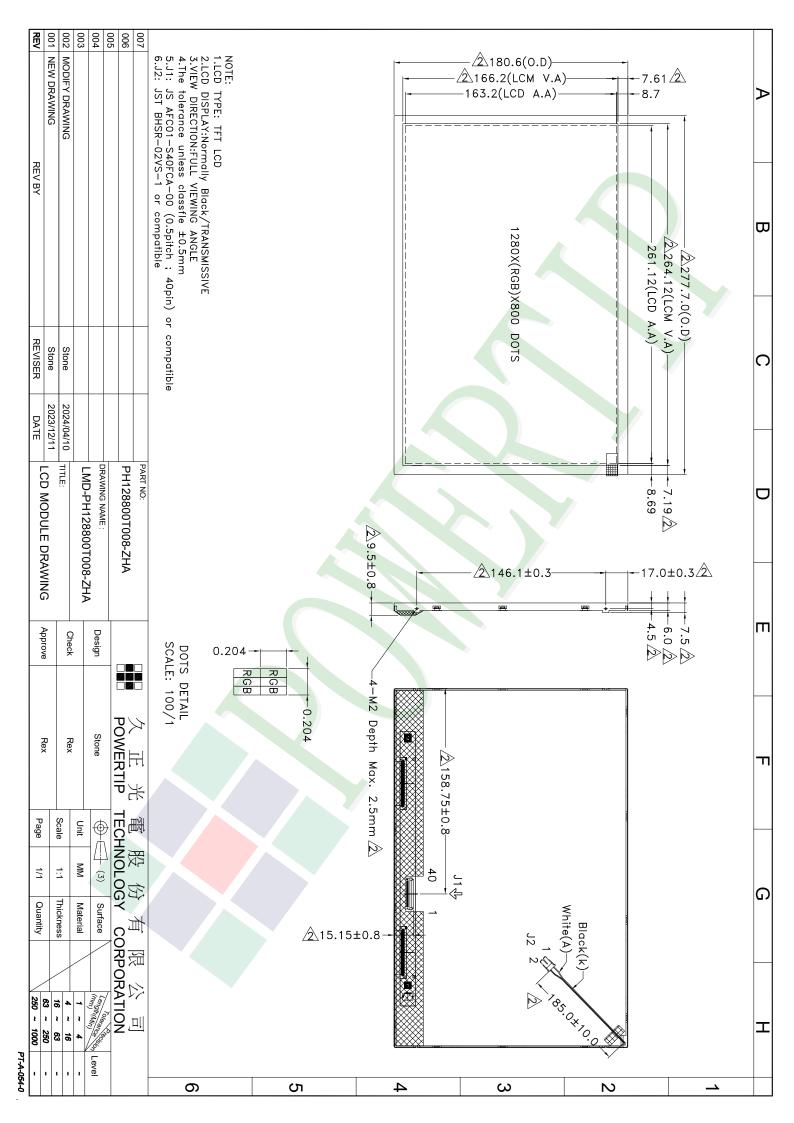
- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So, please handle it very carefully, do not touch, push or rub the exposed polarizing with anything harder than an HB pencil lead (glass, tweezers, etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320 ± 10°C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM
- 5.2.10 Caution!(LCM products with Capacitive Touch Panel)
 Strong EMI-sources such as switch-mode power supplies (SMPS) can lead to touch malfunction (e.g. ghost-touches).
 Therefore, the touch needs to be thoroughly tested inside the target application.
- 5.2.11 CAUTION: Continuously displaying same static image will result in high possibility of image sticking/image burn-in effect due to TFT panel characteristic.
- 5.2.12 Double-sided tape designed to be attach with the customer's mechanical device, please follow up the rules and regulations published by the original manufacturer of double-sided tape for the attachment operation.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25°C ± 5°C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

5.4 TERMS OF WARRANTY

- 5.4.1 Applicable warrant period The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility
 - This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Ver	001			Approve	Check	Contact
Documents NO. PKG-PH128800T008-ZHA Packaging Specifications					Rex	Stone
1.Pa	ackaging Material: (per cartor	1)				
No.	Item	Model	Dimensions (mm)	1Pcs Weight	Quantity	Total Weight
1	成品 (LCM)	PH128800T008-ZHA	277.7 X 180.6	0.395	18	7.11
2	靜電袋(1)Antistatic Bag	BAG000000021	240 X 300	0.008	18	0.144
3	上蓋(2)EPE(Cover)	FOAM00000197	510 X 355 X 55	0.16	1	0.16
4	下座(3)EPE(Bottom)	FOAM00000198	510 X 355 X 100	0.34	1	0.34
5	下蓋板(4)Lower polylon board	OTPLB00PL01ABA	500 X 360 X 10	0.012	1	0.012
6	外紙箱(5)Carton	BX53537327CCBA	535 X 373 X 265	1.1624	1	1.1624
2.一 3 閏	整箱總重量 (Total LCD Weight 箱數量規格表 (Packaging Specifi	in carton): 8.93 Kg±	10%			
	otal LCM quantity in carton: quant		x no of EPE	1 =	18	
	(2)上蓋 EPE(Cover)					>
Aı	(1)靜電袋+LCM htistatic Bag+LCM	I	(4)下蓋板 / .ower polylon board	Ų		
EPF	(3)下座 C(Bottom)	₩	(3)分下級本語 Carton	POWERTEP POWERTEP	O COMME	
		特記事	項 (REMARK)			